

Throughput Analysis for Cluster Tools with Serial and Parallel Modes of Wafer Processing

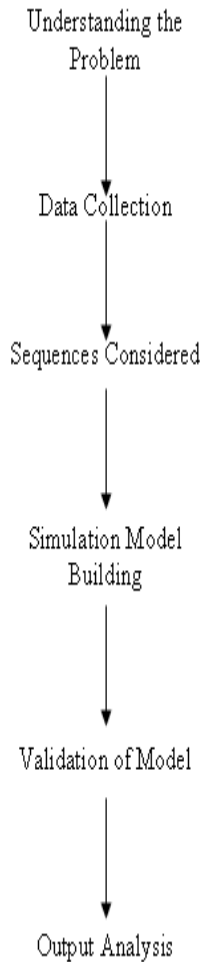
Industry & Systems Engineering



Objective: Conduct throughput analysis on cluster tools to understand their capacity under different configurations and identify the bottleneck processes



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